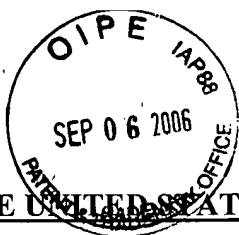


S/N 10/675,921



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Yin Men Lai et al.	Examiner:	Chris Chu
Serial No.:	10/675,921	Group Art Unit:	2815
Filed:	September 30, 2003	Docket:	884.A65US1
Title:	CAPILLARY UNDERFILL AND MOLD ENCAPSULATION METHOD AND APPARATUS		
Assignee:	Intel Corporation	Customer Number:	21186

RESPONSE TO RESTRICTION REQUIREMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This paper responds to the Restriction Requirement mailed on August 8, 2006.